

### 65A, 40V N-CHANNEL MOSFET

#### **DESCRIPTION**

SVGQ047R6NL5V-2HS is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan's LVMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance and high avalanche breakdown tolerance. This device is widely used in 12V motor control system, Start-stop micro-hybrid and so on.

#### **FEATURES**

- AEC-Q101 qualified
- 65A, 40V,  $R_{DS(on)(typ.)}$ =5.5m $\Omega$ @ $V_{GS}$ =10V
- Low gate charge
- Low Crss
- Fast switching
- Extreme dv/dt rated
- 100% avalanche tested
- Pb-free lead plating
- RoHS compliant
- Wettable flanks
- Max. junction temperature: T<sub>imax.</sub>=175°C

# 8 D S 2 S 3 6 D G 4 5 D PDFN-8Q-5X6X1.1-1.27

#### **KEY PERFORMANCE PARAMETERS**

Characteristics	Ratings	Unit
V <sub>DS</sub>	40	V
$V_{GS(th)}$	2.4~3.4	V
R <sub>DS(on),max</sub>	7.6	mΩ
I <sub>D</sub>	65	Α
$Q_{g.typ}$	15	nC

#### **ORDERING INFORMATION**

Part No.	Package	Marking	Hazardous Substance Control	Packing Type	
SVGQ047R6NL5V-2HSTR	PDFN-8Q-5X6X1.1-1.27	Q47R6-2HS	Halogen free	Tape & Reel	

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#### ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, TJ=25°C)

Obanastanistiaa	Comple al	Test conditions	Ratings			l lmit	
Characteristics	Symbol	rest conditions	Min.	Тур.	Max.	Unit	
Drain-source Voltage	V <sub>DS</sub>		40			V	
Gate-source Voltage	$V_{GS}$		-20		20	V	
Drain Current (Note 1)	-	T <sub>C</sub> =25°C			65	Α	
Drain Current (Note 1)	Ι <sub>D</sub>	T <sub>C</sub> =100°C			46	Α	
Drain Current Pulsed (Note 2)	I <sub>DM</sub>	T <sub>C</sub> =25°C			260	Α	
Power Dissipation (Note 3)	P <sub>D</sub>	T <sub>C</sub> =25°C			55	W	
Single Pulsed Avalanche	Eas	L=0.5mH, $V_{DD}$ =32V, $R_G$ =25 $\Omega$ ,			49	mJ	
Energy	∟AS	starting temperature T <sub>J</sub> =25°C					
Single Pulsed Avalanche	,				14	Α	
Current	IAS	las			14	Α	
Operation Junction	TJ	т	-55		175	°C	
Temperature Range	IJ		-00		175	C	
Storage Temperature Range	$T_{stg}$		-55		175	°C	

#### THERMAL CHARACTERISTICS

Characteristics	Symbol	bol Test conditions Min.		Ratings		
Onaracteristics	Symbol			Тур.	Max.	Unit
Thermal Resistance,	D				2.72	°C/W
Junction-case, Bottom	$R_{\theta JC}$					
Thermal Resistance,	В				50	0000
Junction-ambient	$R_{ hetaJA}$				50	°C/W
Soldering Temperature(SMD)	T <sub>sold</sub>	Reflow soldering: 10±1 sec, 3times			260	°C

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#### ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED, TJ=25°C)

#### Static characteristics

Characteristics	Symbol Test conditions	Ratings			Unit	
Characteristics	Symbol	rest conditions	Min.	Тур.	Max.	Offic
Drain-source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	40			V
Drain-source Leakage Current		V <sub>DS</sub> =40V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C			1.0	
	I <sub>DSS</sub>	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V, T <sub>J</sub> =150°C		2.5		μΑ
Gate-source Leakage Current	I <sub>GSS</sub>	$V_{GS}=\pm20V$ , $V_{DS}=0V$			±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}$ , $I_{D}=250\mu A$	2.4	1	3.4	>
Static Drain-source	D	V <sub>GS</sub> =10V, I <sub>D</sub> =20A		5.5	7.6	mΩ
On State Resistance	R <sub>DS(on)</sub>	VGS=10V, ID=20A		5.5	7.0	11122
Gate Resistance	$R_g$	f=1MHz		1.9		Ω

#### **Dynamic characteristics**

Ohawa shawishi a s	Coursels and	Symbol Test conditions	Ratings			I I mid
Characteristics	Symbol		Min.	Тур.	Max.	Unit
Input Capacitance	C <sub>iss</sub>			874		
Output Capacitance	Coss	f=1MHz, V <sub>GS</sub> =0V, V <sub>DS</sub> =25V		290		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			20		
Turn-on Delay Time	t <sub>d(on)</sub>	\\ 00\\\\\ 10\\\\ B 500		7.2		
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}=30V, V_{GS}=10V, R_{G}=5.0\Omega,$		34		
Turn-off Delay Time	t <sub>d(off)</sub>	I <sub>D</sub> =20A		16		ns
Turn-off Fall Time	t <sub>f</sub>	(Notes 4, 5)		13		
Total Gate Charge	Qg			15		
Gate-source Charge	$Q_{gs}$	V <sub>DD</sub> =20V, V <sub>GS</sub> =10V, I <sub>D</sub> =25A		6.0		nC
Gate-drain Charge	$Q_{gd}$	(Notes 4, 5)		2.6		
Gate-plateau Voltage	V <sub>plateau</sub>			5.6		V

#### Reverse diode characteristics

Characteristics	Symbol Test conditions	Ratings			Unit	
Characteristics	Symbol	rest conditions	Min.	Тур.	Max.	Oilit
Continuous Diode Forward Current	I <sub>S</sub>	Integral reverse P-N junction			65	۸
Diode Pulse Current	I <sub>S,pulse</sub>	diode in the MOSFET			260	А
Source-Drain Diode Voltage Drop	$V_{SD}$	I <sub>S</sub> =20A, V <sub>GS</sub> =0V			1.4	V
Reverse Recovery Time	T <sub>rr</sub>	I <sub>S</sub> =20A, V <sub>GS</sub> =0V, V <sub>R</sub> =40V		26		ns
Reverse Recovery Charge	Q <sub>rr</sub>	dI <sub>F</sub> /dt=100A/µs (Note 4)		13		nC

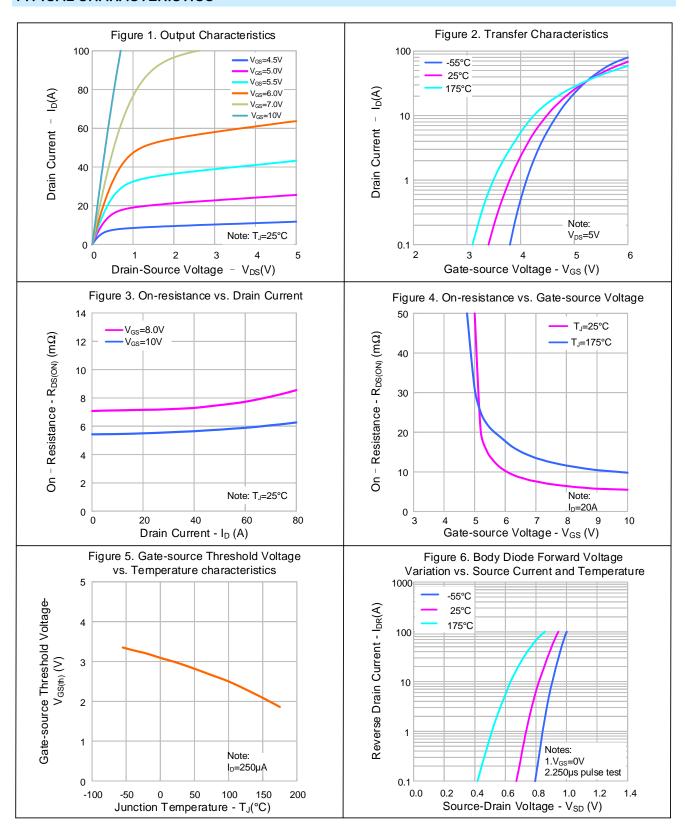
#### Notes:

- The rated value only refers to the maximum absolute value at the case temperature of 25°C in the specification. If the case 1. temperature is higher than 25°C, it should be derated according to the actual environmental conditions;
- 2.
- The dissipation power will change with temperature, derating above 25°C: 0.37W/°C; 3.
- 4. Pulse Test: Pulse width ≤300µs, Duty cycle≤2%;
- Essentially independent of operating temperature. 5.

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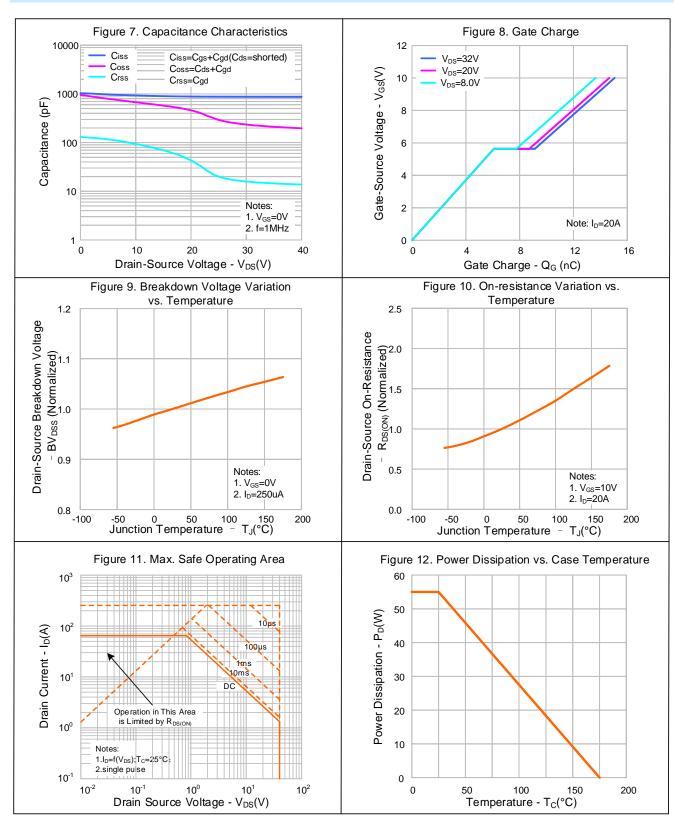
#### TYPICAL CHARACTERISTICS



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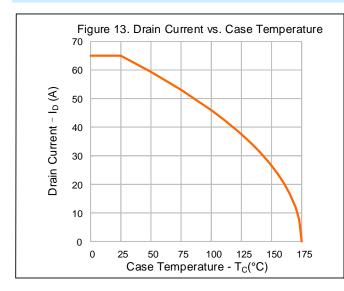
#### **TYPICAL CHARACTERISTICS (CONTINUED)**

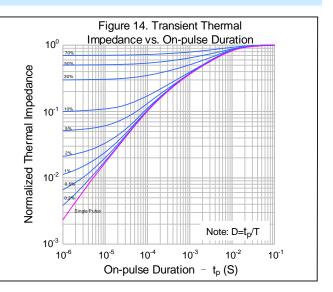


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#### **TYPICAL CHARACTERISTICS (CONTINUED)**



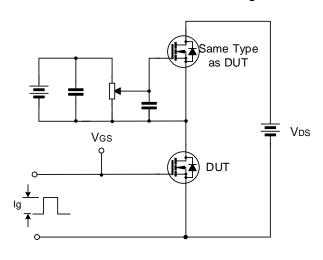


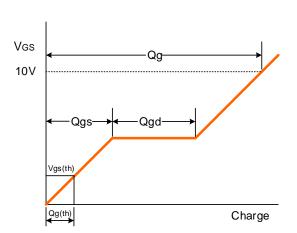
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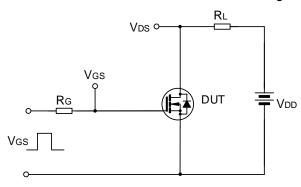
#### **TYPICAL TEST CIRCUIT**

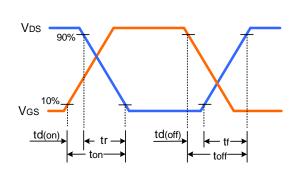
#### Gate Charge Test Circuit & Waveform



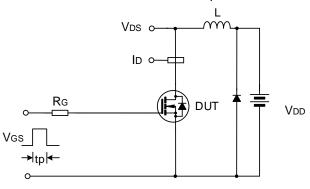


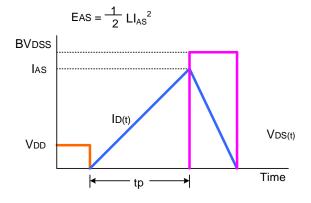
#### Resistive Switching Test Circuit & Waveform





#### Unclamped Inductive Switching Test Circuit & Waveform

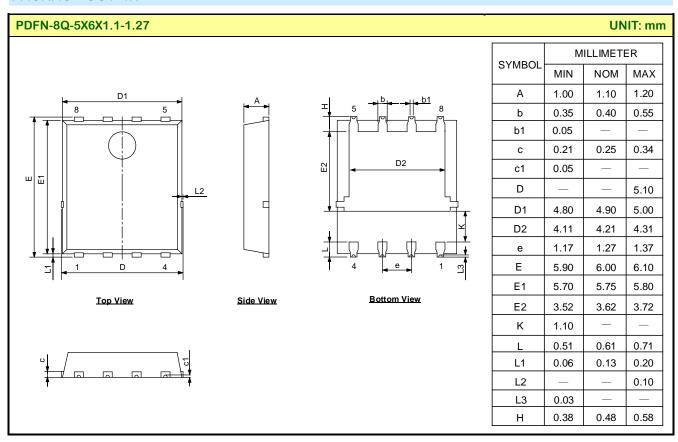




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#### **PACKAGE OUTLINE**





#### **MOS DEVICES OPERATE NOTES:**

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

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#### Important notice:

- Silan reserves the right to make changes of this instruction without notice.
- 2. Customers should obtain the latest relevant information when purchasing and should verify whether such information is latest and complete. Please read this instruction and application manual and related materials carefully before using products, including the circuit operation precautions, etc.
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- 8. Product promotion is endless, our company will wholeheartedly provide customers with better products!
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Part No.: SVGQ047R6NL5V-2HS Document Type: Datasheet

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Rev.: 1.1

Revision History:

Update features

2. Update important notice

Rev.: 1.0

Revision History:

1. First release

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